

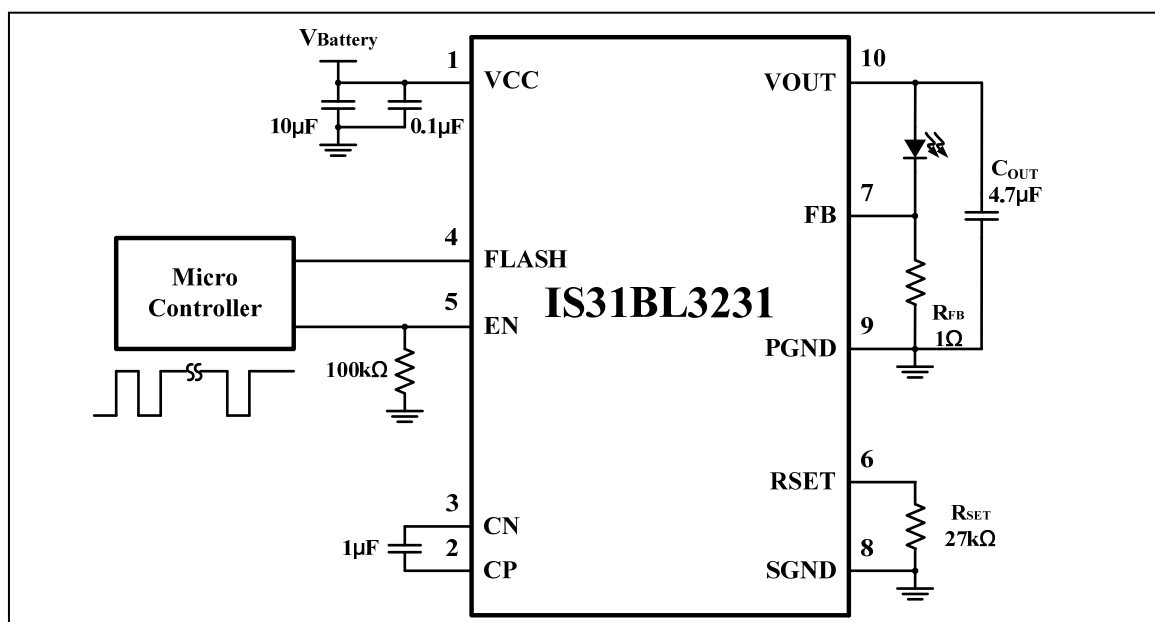


Figure 2 Typical Application Circuit (Torch Mode Lv1-50mA, Flash Mode 518mA)

PIN CONFIGURATION

PIN DESCRIPTION

No.	Pin	Description
1	VCC	Power supply.
2	CP	Positive input for external flying cap.
3	CN	Negative input for external flying cap.
4	FLASH	Input pin to toggle operation between Flash Mode and Torch Mode.
5	EN	Shutdown control input and Torch reference select pin. The intensity can be modulated by PWM signal via EN pin. It is recommended to use 100Hz and 5%~95% duty cycle PWM signal.
6	RSET	Set the FB voltage in Flash Mode. $V_{FB} = (1.25V / R_{SET}) \times 11.2k\Omega$
7	FB	Feedback input for the current control loop. $I_{LED} = V_{FB} / R_{FB}$
8	SGND	Internal ground pin.
9	PGND	Power ground pin.
10	VOUT	Charge pump output voltage.
	Thermal Pad	Connect to GND.

IS31BL3231

ORDERING INFORMATION

Industrial Range: -40°C to +85°C

Order Part No.	Package	QTY/Reel
IS31BL3231-DLS2-TR	DFN-10, Lead-free	2500

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Rev. C, 06/12/2015

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ABSOLUTE MAXIMUM RATINGS

Supply voltage, V_{CC}	-0.3V ~ +6.0V
Voltage at EN pin	0V ~ 7V
Output current pulse (Flash Mode)	1A
Output current pulse (Torch Mode)	0.4A
Maximum junction temperature, T_{JMAX}	+150°C
Storage temperature range, T_{STG}	-65°C ~ +150°C
Operating temperature range, T_A	-40°C ~ +85°C
ESD (HBM)	±7kV
ESD (CDM)	±1kV

Note: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

$T_A = +25^\circ\text{C}$, $V_{CC} = 2.7\text{V} \sim 5.5\text{V}$, unless otherwise stated. Typical value are $T_A = +25^\circ\text{C}$, $V_{CC} = 4.2\text{V}$.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage		2.7		5.5	V
I_{CC}	Quiescent current	$V_{CC} = 4.2\text{V}$, $V_{FLASH} = 0\text{V}$		0.6		mA
I_{SD}	Shutdown current	$V_{CC} = 5.5\text{V}$, $V_{EN} = 0\text{V}$			1	μA
t_{ON}	Charge pump soft start time			550		μs
V_{FB}	FB reference voltage	$V_{FLASH} = V_{CC}$, $R_{SET} = 88.7\text{k}\Omega$		150		mV
		$V_{FLASH} = 0\text{V}$		50		
V_{FB_MAX}	Maximum FB reference voltage	(Note 1)	550			mV
T_{OVP}	Over temperature protection			160		°C
V_{IH}	Input logic high		1.4			V
V_{IL}	Input logic low				0.4	V
t_{LO}	EN low time	(Note 1)	0.3		75	μs
t_{HI}	EN high time	(Note 1)	0.1		75	μs
t_{OFF}	EN shutdown timeout	(Note 1)		500		μs
t_{LAT}	EN latch timeout	(Note 1)		500		μs

Note 1: Guaranteed by design.

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TYPICAL PERFORMANCE CHARACTERISTICS

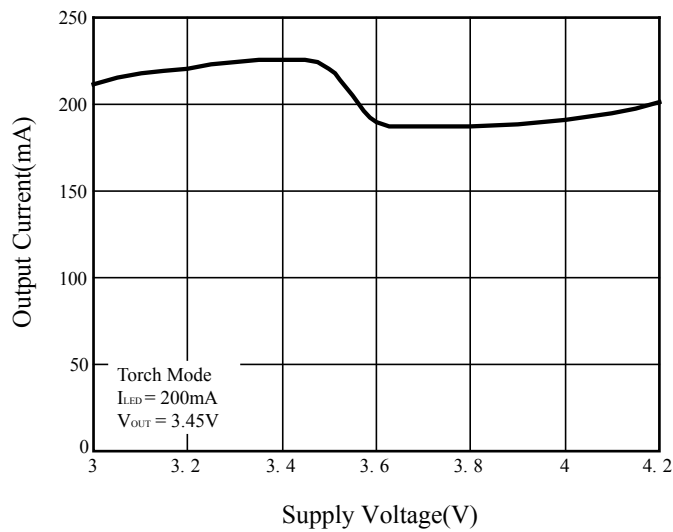


Figure 3 Supply Voltage vs. Output Current (Torch Mode)

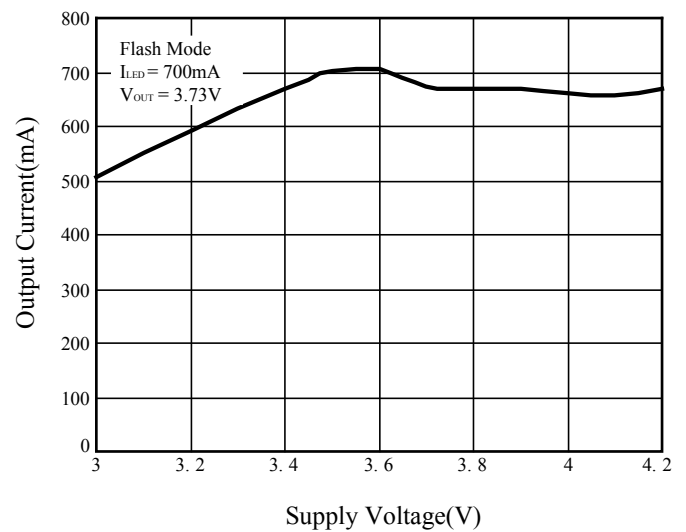


Figure 4 Supply Voltage vs. Output Current (Flash Mode)

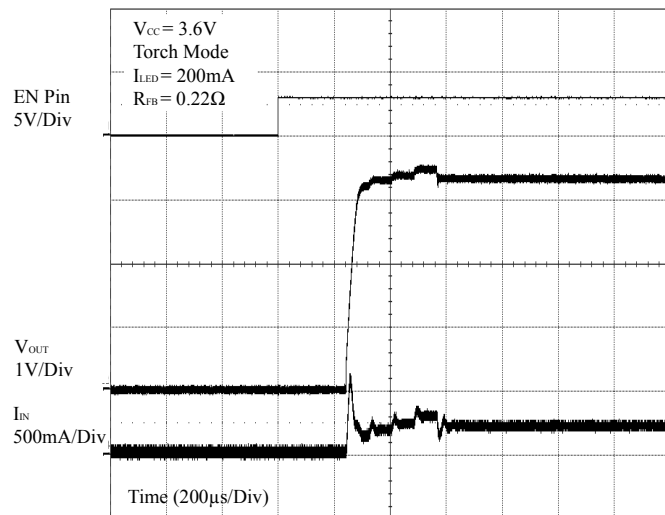


Figure 5 EN On (Torch Mode)

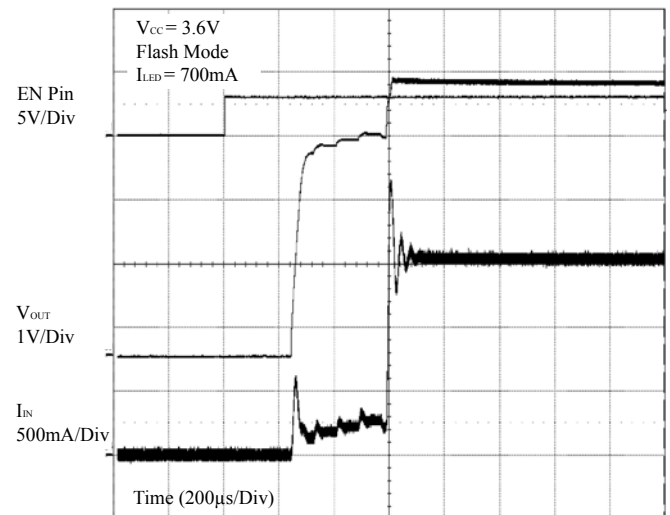


Figure 6 EN On (Flash Mode)

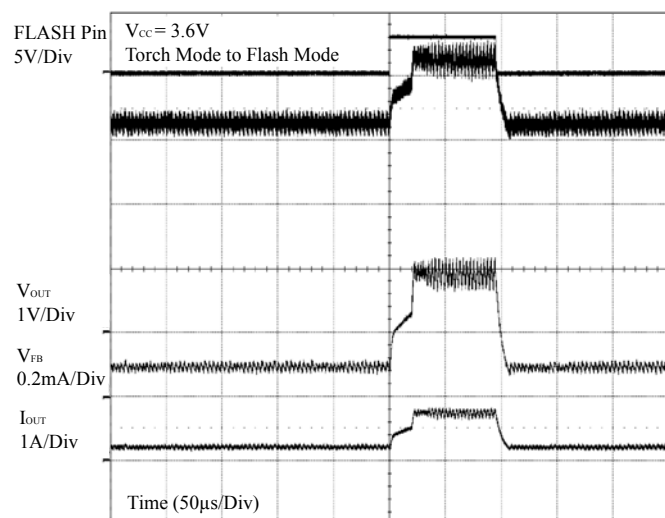


Figure 7 Torch Mode to Flash Mode

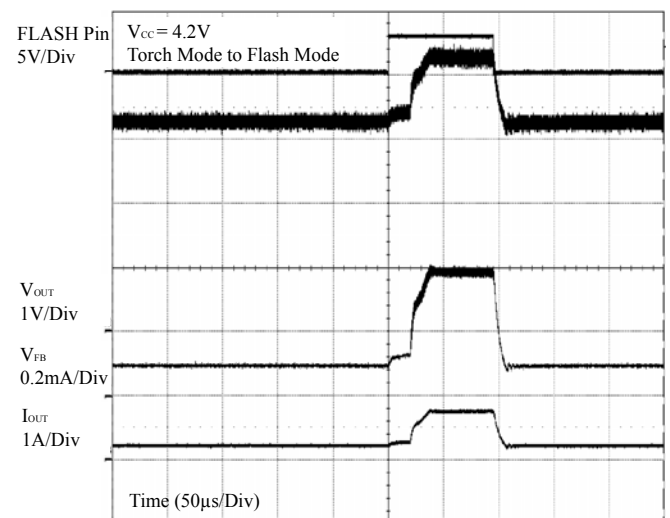


Figure 8 Torch Mode to Flash Mode

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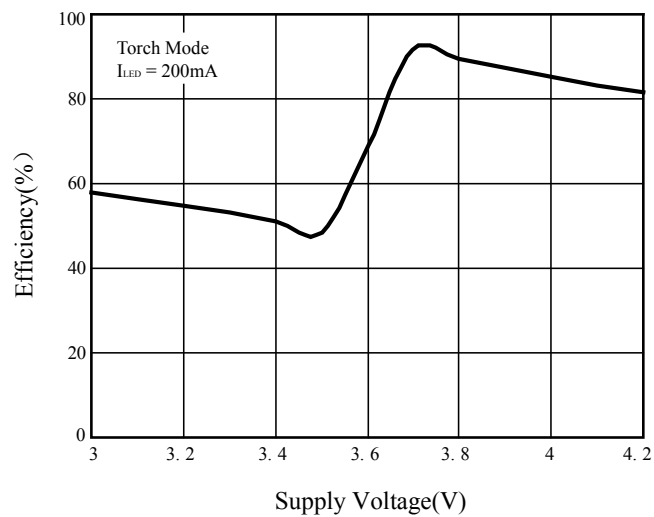


Figure 9 Supply Voltage vs. Efficiency (Torch Mode)

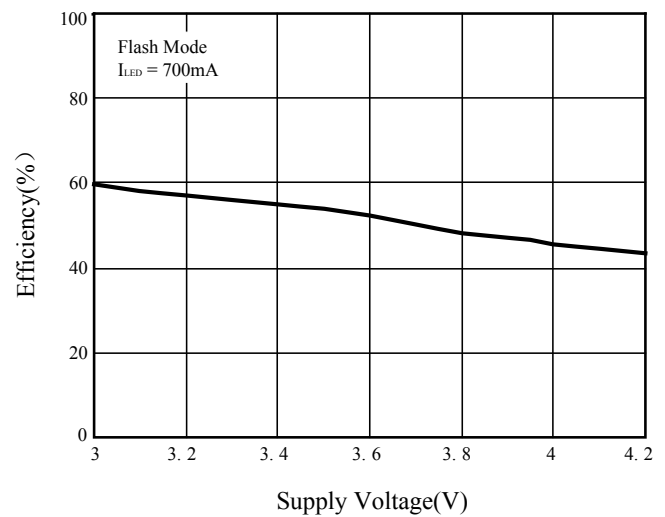
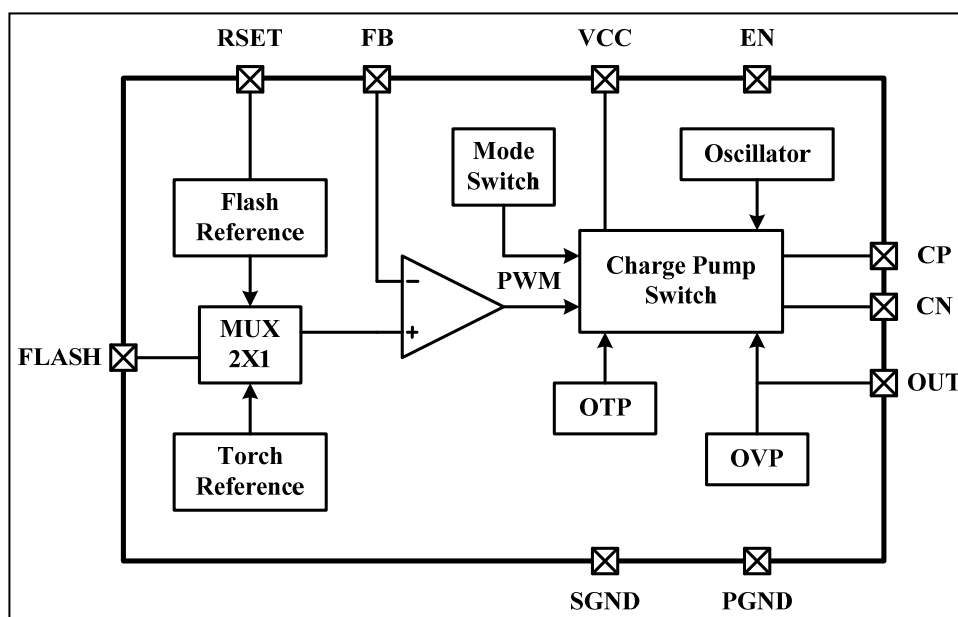


Figure 10 Supply Voltage vs. Efficiency (Flash Mode)

IS31BL3231

FUNCTIONAL BLOCK DIAGRAM



IS31BL3231

APPLICATION INFORMATION

GENERAL DESCRIPTION

The IS31BL3231 is a current-regulated charge pump and ideal for powering high brightness LEDs for camera flash and torch applications.

CHARGE PUMP

The charge pump converter boosts input supply voltage (V_{CC}) up to a higher output voltage (V_{OUT}) to drive LED.

The charge pump converter only requires three external components: supply decoupling capacitor, output bypass capacitor and flying capacitor.

Choose low ESR capacitors to ensure the best operating performance and place the capacitors as close as possible to the IS31BL3231.

The charge pump will start up automatically to offer a higher output voltage when V_{FB} is lower than the setting value.

CURRENT SETTING

The LED current is set by the external resistor, R_{FB} , following the Equation (1) below.

$$I_{LED} = V_{FB} / R_{FB} \quad (1)$$

V_{FB} is calculated by the Equation (2) when IS31BL3231 operates in the Flash Mode. V_{FB} is set in the Table 1 when IS31BL3231 operates in the Torch Mode.

OPERATING MODE

FLASH MODE

By pulling the FLASH pin to high, IS31BL3231 operates in the Flash Mode. V_{FB} is set by the R_{SET} .

$$V_{FB} = (1.25V / R_{SET}) \times 11.2k\Omega \quad (2)$$

For example, in Figure 1,

$R_{FB} = 0.22\Omega$, $R_{SET} = 88.7k\Omega$,

So, $V_{FB} = (1.25V / 88.7k\Omega) \times 11.2k\Omega \approx 158mV$

$$I_{LED} = 158mV / 0.22\Omega \approx 718mA$$

The maximum V_{FB} shouldn't be over 550mV or the actual current will be large difference from then calculated current.

TORCH MODE

By pulling the FLASH pin to low, IS31BL3231 operates in the Torch Mode. The V_{FB} is controlled by Pulse Count Control (PCC wire) serial interface. The interface records rising edges of the EN pin and decodes them into 8 different states. The 8 voltage level settings available are indicated in Table 1.

Table 1 V_{FB} Control

Pulse	V_{FB} (Typ.)	I_{LED} (Typ.)	
		$R_{FB} = 0.22\Omega$	$R_{FB} = 1\Omega$
1	50mV	227mA	50mA
2	60mV	273mA	60mA
3	70mV	318mA	70mA
4	85mV	386mA	85mA
5	100mV	455mA	100mA
6	120mV	545mA	120mA
7	140mV	636mA	140mA
≥ 8	170mV	773mA	170mA

TIMING CONTROL

The EN pin should be configured as the Figure 11. t_{LAT} is the latch time. High level should be at last t_{LAT} to active the pulse signal. t_{OFF} is the shutdown time. EN pin is pulled low at last t_{OFF} the IC will be shutdown.

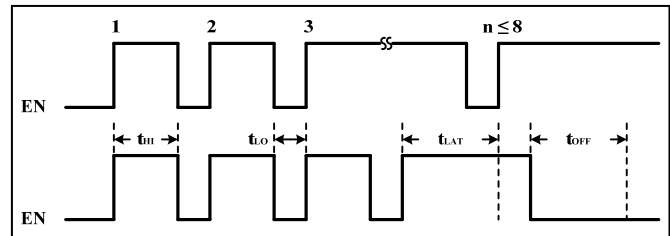


Figure 11 EN pin timing

THERMAL PROTECTION

The IS31BL3231 has a thermal protection circuit that will shut down the chip if the die temperature rises above the thermal limit until the temperature falls down.

IS31BL3231

CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (T _{smin}) Temperature max (T _{smax}) Time (T _{smin} to T _{smax}) (t _s)	150°C 200°C 60-120 seconds
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.
Liquidous temperature (T _L) Time at liquidous (t _L)	217°C 60-150 seconds
Peak package body temperature (T _p)*	Max 260°C
Time (t _p)** within 5°C of the specified classification temperature (T _c)	Max 30 seconds
Average ramp-down rate (T _p to T _{smax})	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

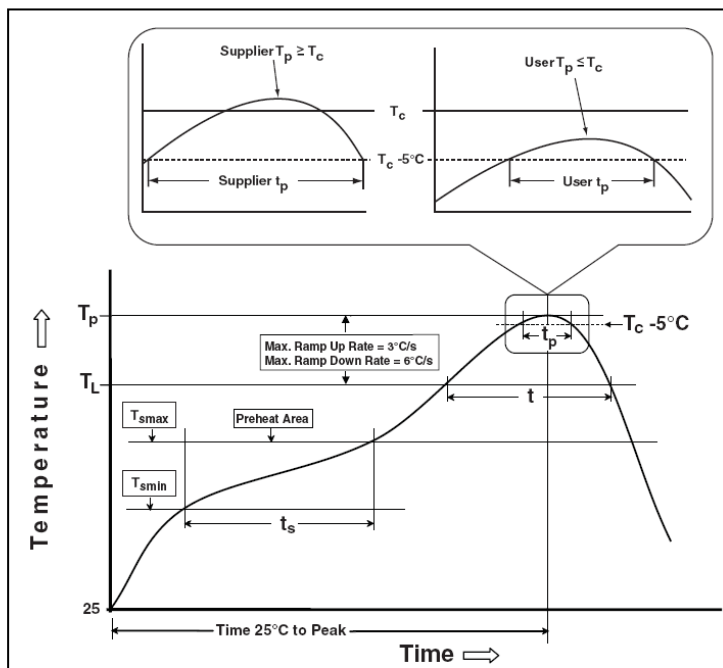
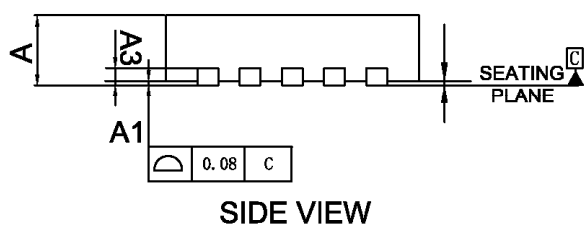
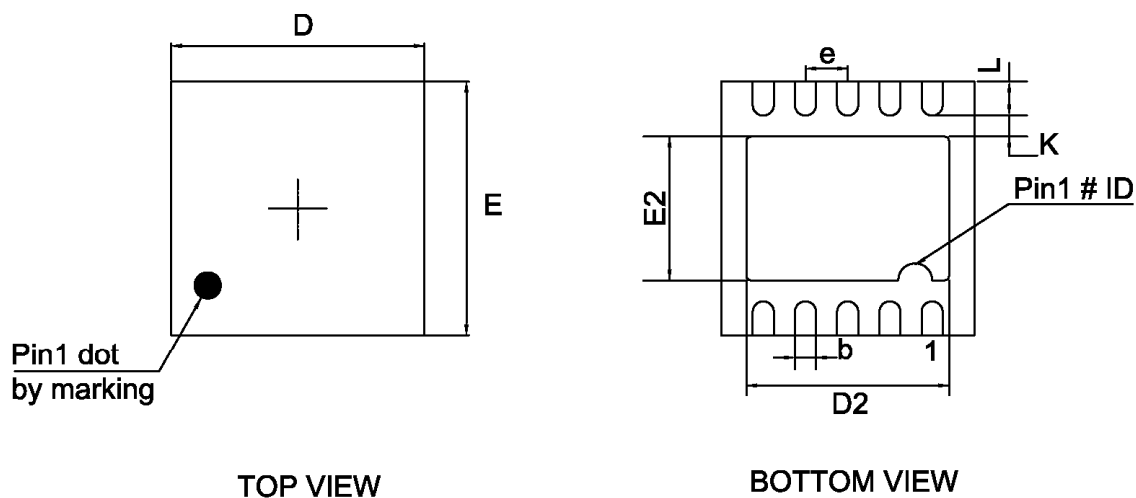


Figure 12 Classification Profile

IS31BL3231

PACKAGE INFORMATION

DFN-10



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	—	0.05
A3	0.20REF		
D	2.90	3.00	3.10
E	2.90	3.00	3.10
E2	1.40	—	1.75
D2	2.20	—	2.70
b	0.18	0.25	0.30
L	0.30	0.40	0.50
K	0.20	—	—
e	0.50 BSC		

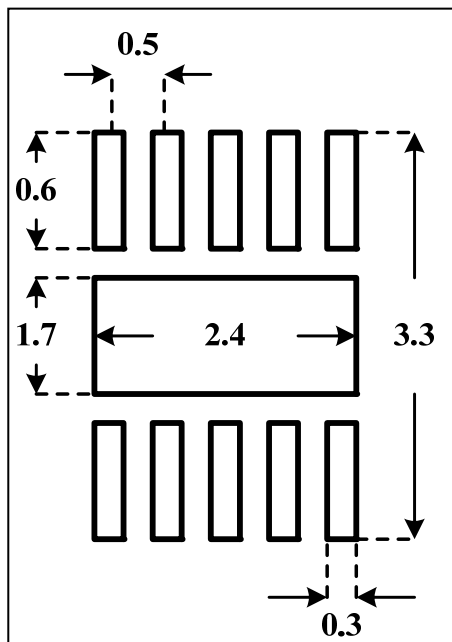
NOTE:

1. CONTROLLING DIMENSION : MM
2. REFERENCE DOCUMENT: JEDEC MO-229F
3. THE PIN'S SHARP AND THERMAL PAD SHOWS DIFFERENT SHAPE AMONG DIFFERENT FACTORIES.

Note: All dimensions in millimeters unless otherwise stated.

IS31BL3231

RECOMMENDED LAND PATTERN



Note:

1. Land pattern complies to IPC-7351.
2. All dimensions in MM.
3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. user's board manufacturing specs), user must determine suitability for use.

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REVISION HISTORY

Revision	Detail Information	Date
A	Initial release	2012.01.16
B	1. P.7 add efficiency chart 2. P.2 add application figure in 50mA(Torch), 500mA(Flash) 3. P.3 add PWM dimming function 4. P.5 remove ESD	2012.12.03
C	1. Add land pattern 2. Correct 100kHz to 100Hz in Pin Description 3. Add ESD value	2015.06.12